

PROTECTION PRODUCTS

Description

The RClamp®0582B transient voltage suppressor is specifically designed to protect sensitive components which are connected to high-speed data and transmission lines from overvoltage caused by ESD (electrostatic discharge), CDE (cable discharge events), and EFT (electrical fast transients).

The RClamp®0582B features high peak pulse current capability ($I_{pp}=15A$, $t_p=8/20\mu s$) for use in applications that require high surge immunity testing. It has a maximum capacitance of only 1.2pF (pin 1 or 2 to pin3). They may be used to meet the ESD immunity requirements of IEC 61000-4-2 ($\pm 30kV$ air, $\pm 25kV$ contact discharge). Each device can be configured to protect 1 bidirectional line or two unidirectional lines.

These devices are in a small SC-75 (SOT-523) package and feature a lead-free, matte tin finish. They are compatible with both lead free and SnPb assembly techniques. The combination of small size, low capacitance, and high level of surge protection makes them a flexible solution for protection of USB 2.0, LVDS, and video interfaces.

Features

- Transient protection for high-speed data lines to IEC 61000-4-2 (ESD) $\pm 30kV$ (air), $\pm 25kV$ (contact) IEC 61000-4-4 (EFT) 40A (5/50ns)
- Protects up to two I/O lines
- Low capacitance ($<1.2pF$)
- High surge capability: 15A ($t_p=8/20\mu s$)
- Low leakage current and clamping voltage
- Low operating voltage: 5.0V
- Solid-state silicon-avalanche technology

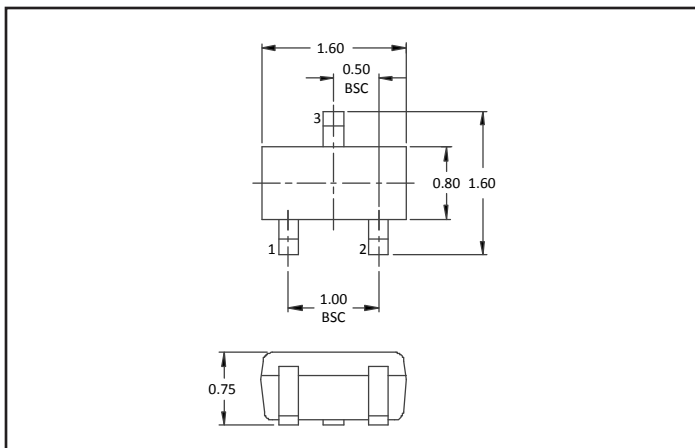
Mechanical Characteristics

- SC-75 (SOT-523) package
- Lead Finish: Matte Tin
- Pb-Free, Halogen Free, RoHS/WEEE Compliant
- Molding compound flammability rating: UL 94V-0
- Packaging: Tape and Reel

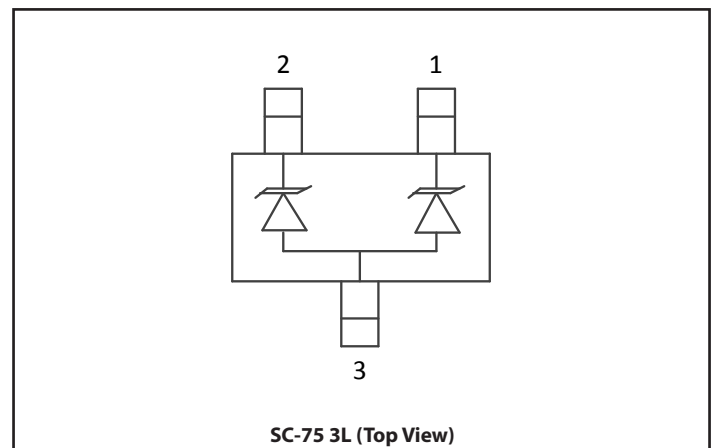
Applications

- USB 2.0
- Video Lines
- LVDS Lines
- Networking equipment

Nominal Dimensions (mm)



Schematic & Pin Configuration



Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20\mu s$)	P_{PK}	300	W
Peak Pulse Current ($t_p = 8/20\mu s$)	I_{PP}	15	A
ESD per IEC 61000-4-2 (Air) ⁽¹⁾ ESD per IEC 61000-4-2 (Contact) ⁽¹⁾	V_{ESD}	± 30 ± 25	kV
Operating Temperature	T_J	-40 to +105	°C
Storage Temperature	T_{STG}	-55 to +150	°C

Electrical Characteristics (T=25°C unless otherwise specified)

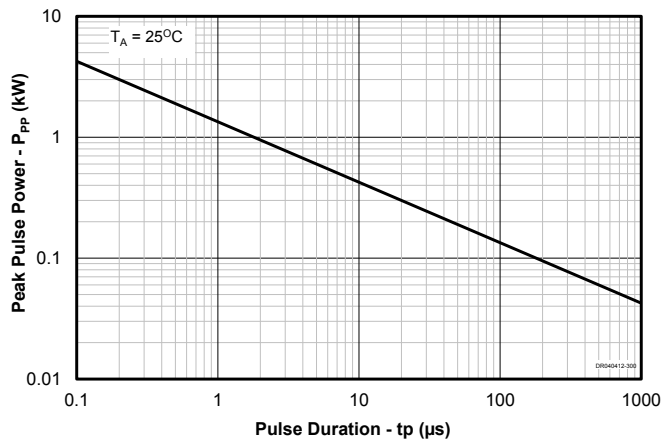
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Reverse Stand-Off Voltage	V_{RWM}	Pin 1 or Pin 2 to Pin 3			5	V
Reverse Breakdown Voltage	V_{BR}	$I_{BR} = 1mA$, Pin 1 to Pin 2 to Pin 3	6		11	V
Reverse Leakage Current	I_R	$V_{RWM} = 5V$, $T = 25^\circ C$, Pin 1 or Pin 2 to Pin 3 and between Pin 1 and 2			0.1	μA
Reverse Leakage Current	I_R	$V_{RWM} = 5V$, $T = 105^\circ C$, Pin 1 or Pin 2 to Pin 3 and between Pin 1 and 2			0.3	μA
Clamping Voltage	V_C	$t_p = 8/20\mu s$ Pin 1 or Pin 2 to Pin 3 $I_{PP} = 5A$			15	V
		$t_p = 8/20\mu s$ Pin 1 or Pin 2 to Pin 3 $I_{PP} = 15A$			20	
ESD Clamping Voltage ²	V_C	$t_p = 0.2/100ns$ Pin 1 or Pin 2 to Pin 3 $I_{PP} = 4A$		14		V
		$I_{PP} = 16A$		20		
Dynamic Resistance ^{2,3}	R_{DYN}	$t_p = 0.2/100ns$, Pin 1 or Pin 2 to Pin 3		0.52		Ω
Junction Capacitance	C_J	$V_R = 0V$, $f = 1MHz$ Pin 1 to Pin 2		0.5	0.8	pF
Junction Capacitance	C_J	$V_R = 0V$, $f = 1MHz$ Pin 1 or Pin 2 to Pin 3			1.2	pF

Notes:

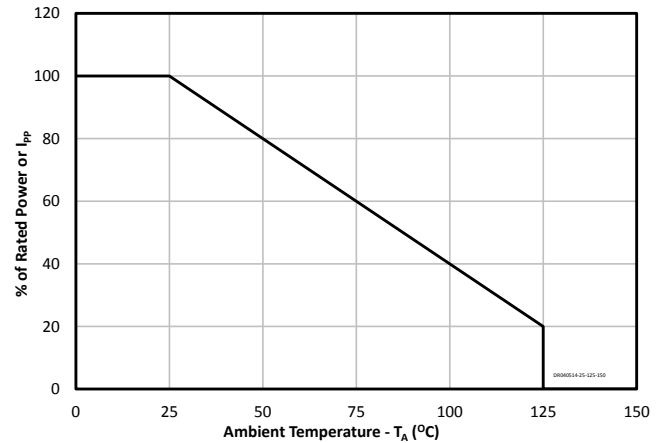
- 1) ESD gun return path connected to ESD ground plane.
- 2) Transmission Line Pulse Test (TLP) Settings: $t_p = 100ns$, $t_r = 0.2ns$, I_{TLP} and V_{TLP} averaging window: $t_1 = 70ns$ to $t_2 = 90ns$.
- 3) Dynamic resistance calculated from $I_{TLP} = 4A$ to $I_{TLP} = 16A$

Typical Characteristics

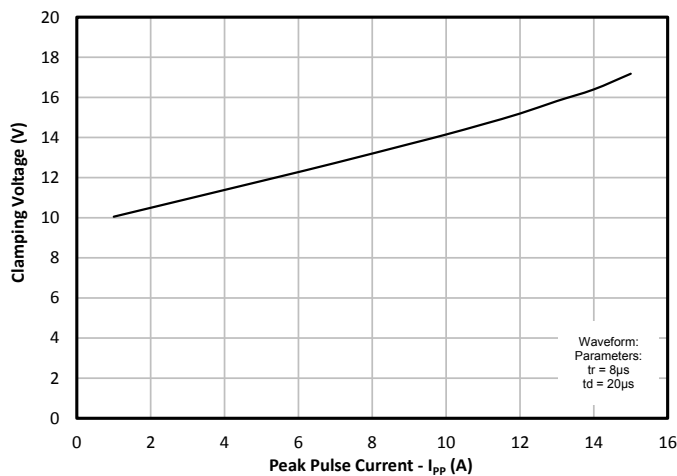
Non Repetitive Peak Pulse Power vs. Pulse Time



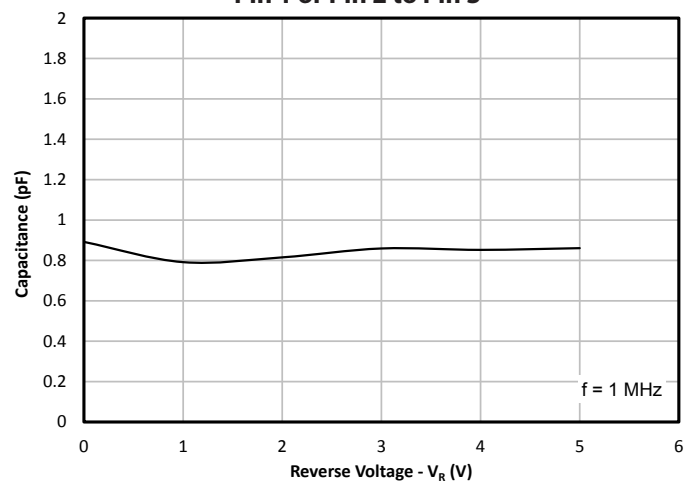
Power Derating Curve



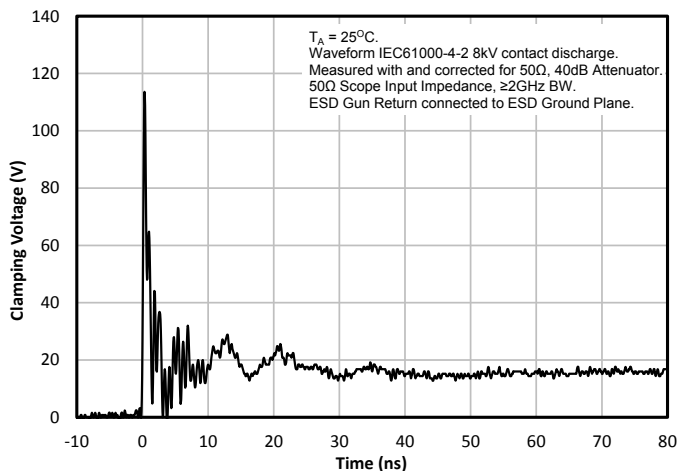
**Clamping Voltage vs. Peak Pulse Current ($t_p=8/20\mu$ s)
Pin 1 or Pin 2 to Pin 3**



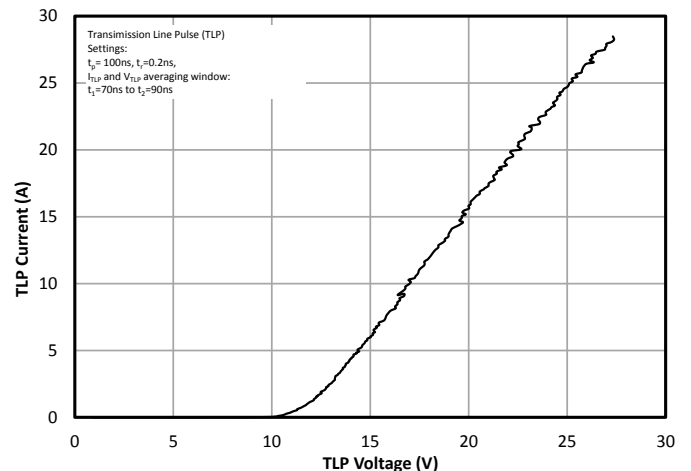
**Capacitance vs. Reverse Voltage
Pin 1 or Pin 2 to Pin 3**



**ESD Clamping (8kV Contact per IEC 61000-4-2)
Pin 1 or Pin 2 to Pin 3**

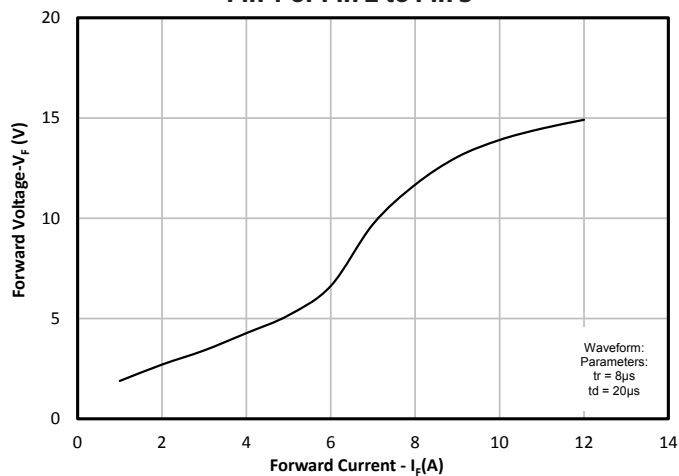


**TLP Characteristic
Pin 1 or Pin 2 to Pin 3**

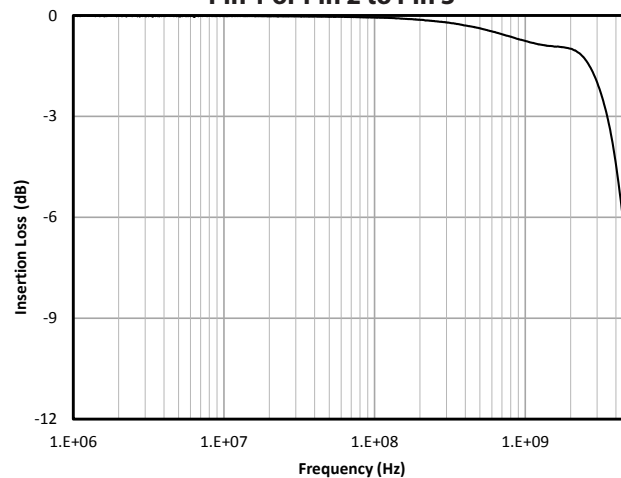


Typical Characteristics (Continued)

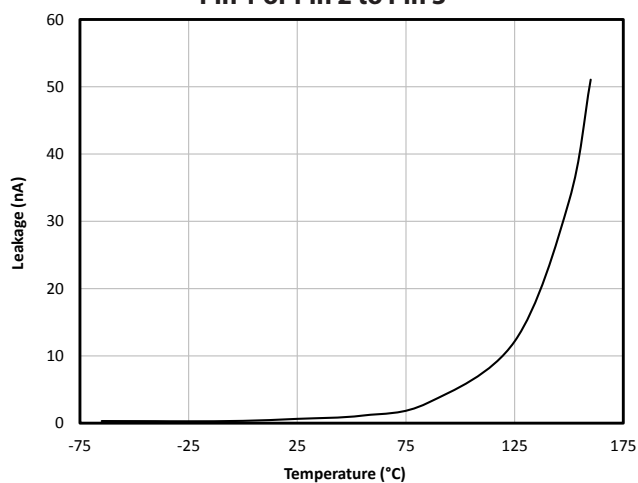
**Forward Voltage vs. Forward Current ($t_p=8/20\mu s$)
Pin 1 or Pin 2 to Pin 3**



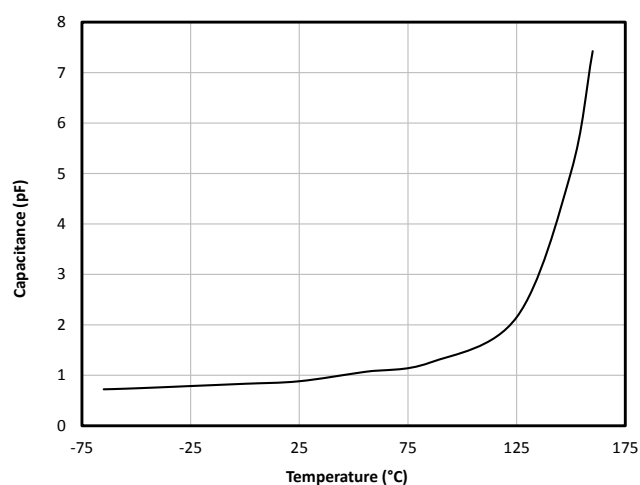
**Insertion Loss S21
Pin 1 or Pin 2 to Pin 3**



**Reverse Leakage Current vs. Temperature
Pin 1 or Pin 2 to Pin 3**



Capacitance vs. Temperature



Application Information

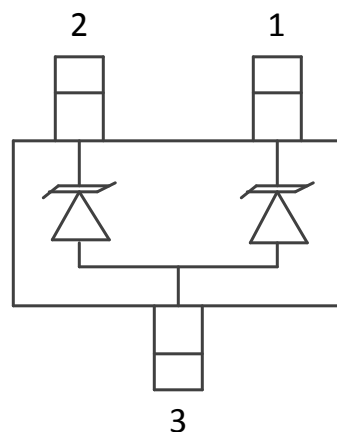
Device Connection Options

This device is optimized for protection of two high speed data lines. The device is connected as follows: Protection of two lines is achieved by connecting data lines at pins 1 & 2. Pin 3 is connected to ground. The connection to ground should be made directly to a ground plane. The path length should also be kept as short as possible to minimize parasitic inductance.

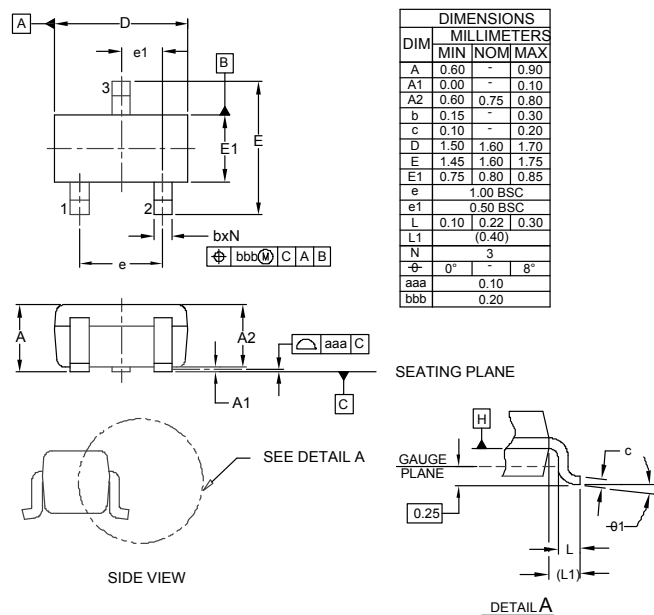
Matte Tin Lead Finish

Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. In addition, unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation of the solder joint.

Figure 1. Pin Configuration

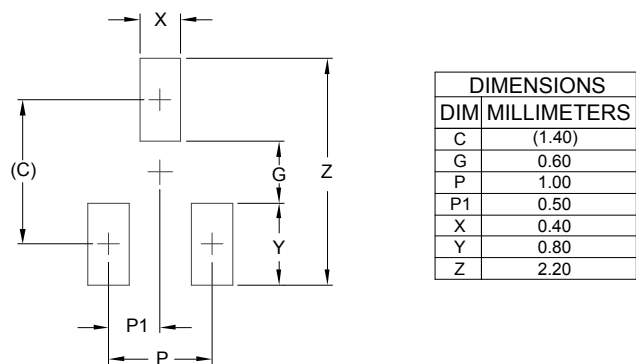


Outline Drawing - SC75 3L



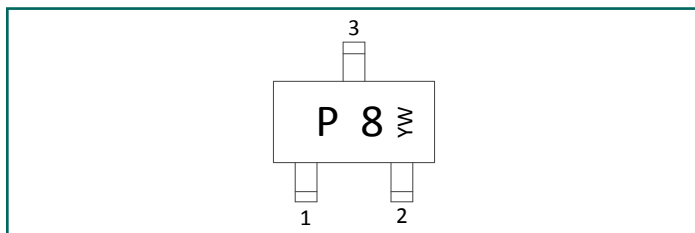
- NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
 2. DATUMS $\boxed{-A-}$ AND $\boxed{-B-}$ TO BE DETERMINED AT DATUM PLANE $\boxed{-H-}$.
 3. DIMENSIONS "E1" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

Land Pattern - SC75 3L



- NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY
CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR
COMPANY'S MANUFACTURING GUIDELINES ARE MET.

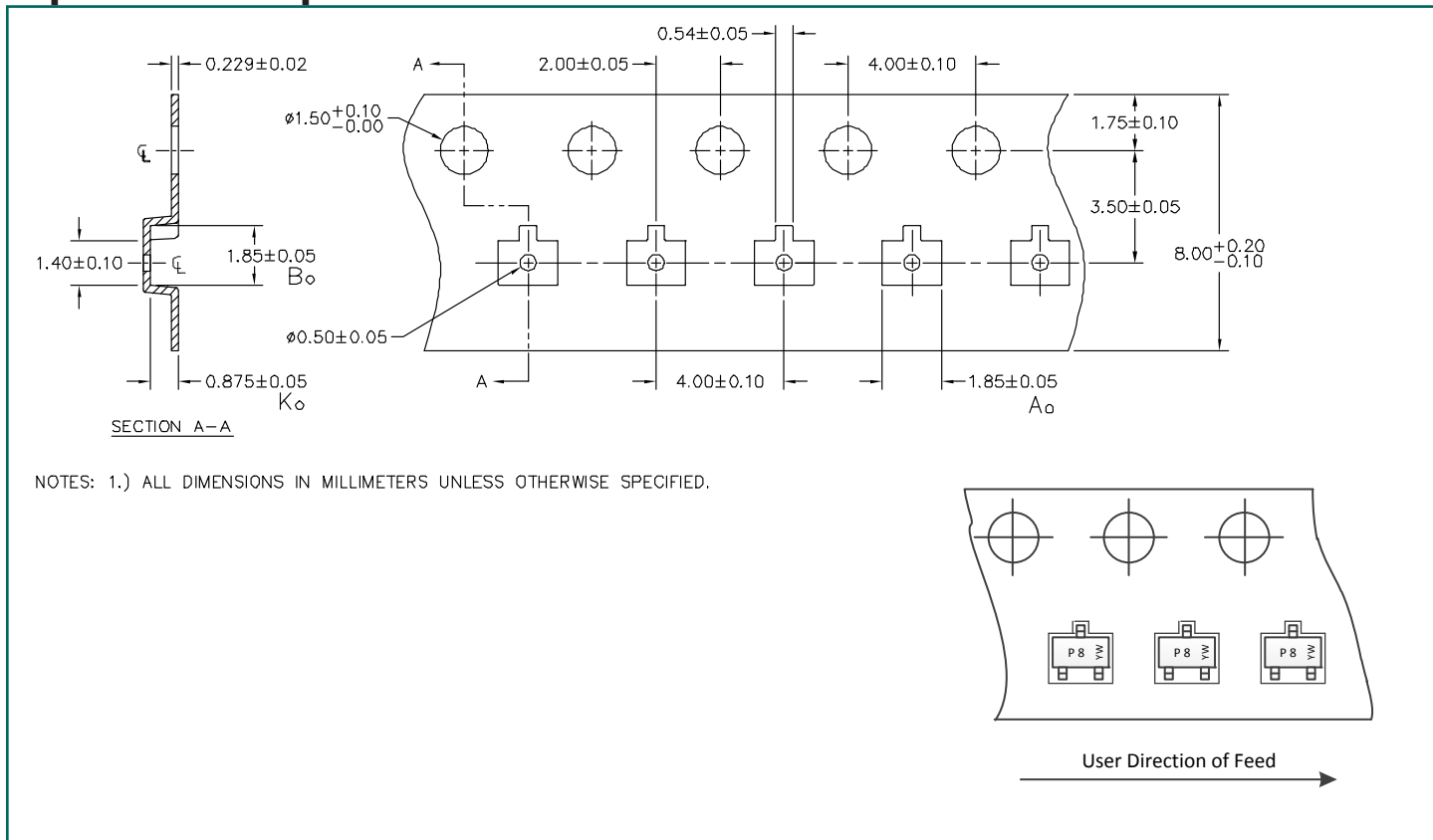
Marking Code



Note:

YW= Date Code

Tape and Reel Specification



Ordering Information

Part Number	Qty per Reel	Reel Size
RClamp0582B.TCT	3,000	7"



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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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